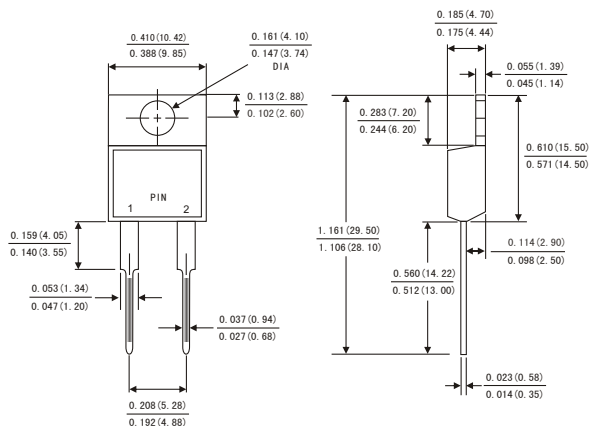


## FEATURES

- Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- Metal silicon junction ,majority carrier conduction
- Guard ring for overvoltage protection
- Low power loss ,high efficiency
- High current capability ,Low forward voltage drop
- Single rectifier construction
- High surge capability
- For use in low voltage ,high frequency inverters, free wheeling ,and polarity protection applications
- High temperature soldering guaranteed:260°C/10 seconds, 0.25"(6.35mm)from case
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC



## TO-220AC



Dimensions in inches and (millimeters)

## MECHANICAL DATA

- Case: JEDEC TO-220AC molded plastic body
- Terminals: Lead solderable per MIL-STD-750,method 2026
- Polarity: As marked
- Mounting Position: Any
- Weight: 0.08ounce, 2.24 gram

## MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(Ratings at 25°C ambient temperature unless otherwise specified ,Single phase ,half wave ,resistive or inductive load. For capacitive load,derate by 20%.)

	Symbols	SR 620	SR 630	SR 640	SR 650	SR 660	SR 680	SR 6100	SR 6150	SR 6200	Units	
Maximum repetitive peak reverse voltage	$V_{RRM}$	20	30	40	50	60	80	100	150	200	Volts	
Maximum RMS voltage	$V_{RMS}$	14	21	28	35	42	57	71	105	140	Volts	
Maximum DC blocking voltage	$V_{DC}$	20	30	40	50	60	80	100	150	200	Volts	
Maximum average forward rectified current 0.375"(9.5mm) lead length(see fig.1)	$I_{(AV)}$	6.0									Amps	
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC method at rated $T_J$ )	$I_{FSM}$	150.0									Amps	
Maximum instantaneous forward voltage at 6.0 A(Note 1 )	$V_F$	0.60			0.75		0.85		0.90		0.95	Volts
Maximum instantaneous reverse current at rated DC blocking voltage(Note 1)	$I_R$	$T_A = 25^\circ C$	0.2									mA
		$T_A = 100^\circ C$	50			25						
Typical junction capacitance(Note 3)	$C_J$	500			400						pF	
Typical thermal resistance (Note 2)	$R_{\theta JA}$ $R_{\theta JL}$	25.0									°C/W	
		8.0										
Operating junction temperature range	$T_J$	-65 to +150									°C	
Storage temperature range	$T_{STG}$	-65 to +150									°C	

Notes: 1.Pulse test: 300  $\mu$ s pulse width,1% duty cycle

2.Thermal resistance from junction to lead vertical P.C.B. mounted , 0.375"(9.5mm)lead length

3.Measured at 1MHz and reverse voltage of 4.0volts

# RATINGS AND CHARACTERISTIC CURVES SR620 THRU SR6200(SINGLE CHIP)

FIG.1-FORWARD CURRENT DERATING CURVE

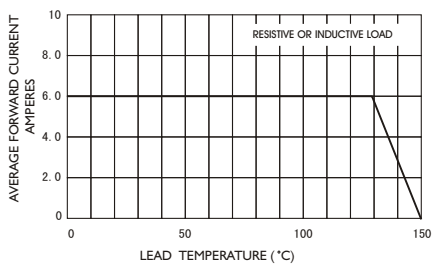


FIG.2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

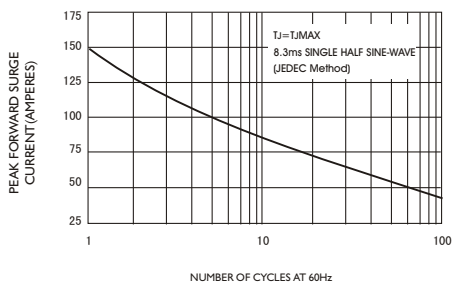


FIG.3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

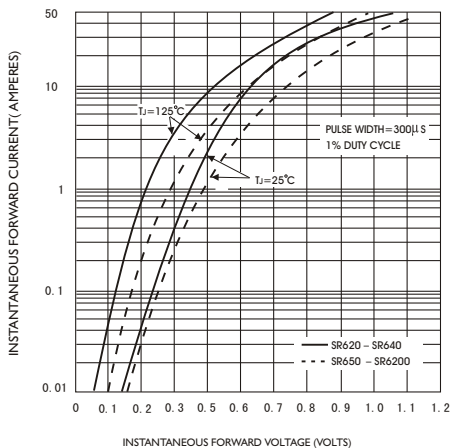


FIG.4-TYPICAL REVERSE CHARACTERISTICS

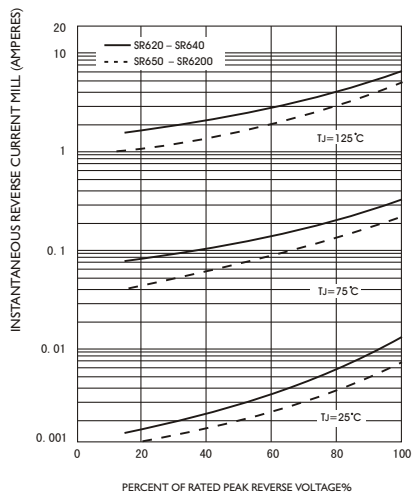


FIG.5-TYPICAL JUNCTION CAPACITANCE

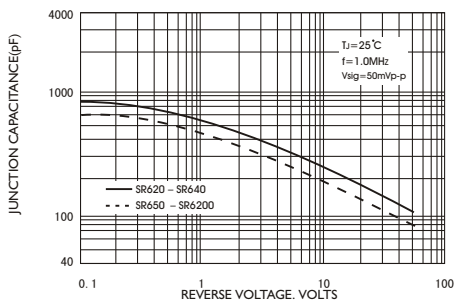


FIG.6-TYPICAL TRANSIENT THERMAL IMPEDANCE

